LM317 3 端可调稳压器

1 特性

- 1.25V 至 37V 可调节输出电压范围
- 输出电流大于 1.5A
- 内部短路电流限制
- 热过载保护
- 输出安全区域补偿

2 应用

- ATCA 解决方案
- DLP：3D 生物辨识、高光谱成像、光纤网络和光谱分析
- DVR 和 DVS
- 台式计算机
- 数字标牌和静物照相机
- 心电图 (ECG)
- EV HEV 充电器：1 级、2 级和 3 级
- 电子货架标签
- 能量收集
- 以太网交换机
- Femto 基站
- 指纹识别和虹膜识别
- HVAC：采暖、通风和空调
- 高速数据采集和生成
- 液压阀
- IP 电话：有线和无线
- 智能在场感应
- 电机控制：刷式直流、无刷直流、低电压、永久磁性和步进电机
- 点对点微波回程连线
- 移动电源解决方案
- 电力线通信调制解调器
- 以太网供电 (PoE)
- 电能质量检测仪
- 变电站控制
- 专用交换机 (PBX)
- 可编程逻辑控制器
- RFID 读取器
- 冰箱
- 信号/波形发生器
- 软件无线电 (SDR)
- 洗衣机：高端和低端
- X 射线：行李扫描仪、医疗和牙科

3 说明

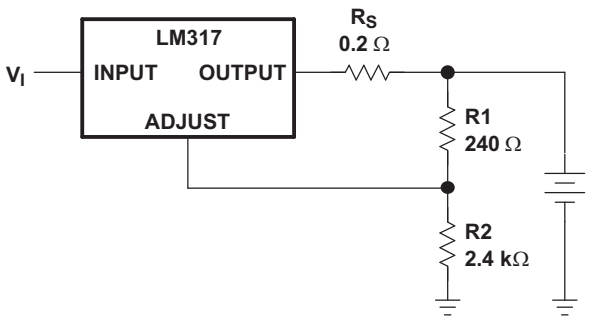
LM317 器件是一款可调节 3 端正电压稳压器，能够在 1.25V 至 37V 的输出电压范围内提供超过 1.5A 的电流。它仅需要使用两个外部电阻器来设置输出电压。该器件 具有 0.01% 的典型线性调整率和 0.1% 的典型负载调整率。它包含电流限制、热过载保护和安全工作区保护功能。即使“调节”端处于断开状态，过载保护功能仍然起作用。

器件信息(1)

器件型号	封装	封装尺寸（标称值）
LM317DCY	SOT-223 (4)	6.50mm x 3.50mm
LM317KCS	TO-220 (3)	10.16mm × 9.15mm
LM317KCT	TO-220 (3)	10.16mm × 8.59mm
LM317KTT	TO-263 (3)	10.16mm × 9.01mm

(1) 如需了解所有可用封装，请参阅数据表末尾的可订购产品附录。

电池充电器电路



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4 修订历史记录

Changes from Revision W (January 2015) to Revision X **Page**

- 已更改 在*器件信息* 表中更改了 KCS TO-220 的封装尺寸 ... 1
- 已更改 在*器件信息* 表中更改了 KTT TO-263 的封装尺寸 ... 1
- Changed V_O Output Voltage max value from 7 to 37 on *Recommended Operating Conditions* table ... 4
- Added min value to I_O Output Current in *Recommended Operating Conditions* table ... 4
- Changed values in the Thermal Information table to align with JEDEC standards ... 4
- Added KCT package data to *Thermal Information* table ... 4
- Deleted Section 9.3.6 "Adjusting Multiple On-Card Regulators with a Single Control" ... 13
- Updated Adjustsable 4-A Regulator Circuit graphic ... 16
- 已添加 *添加了接收文档更新通知* 部分和*社区资源* 部分 ... 19

Changes from Revision V (February 2013) to Revision W **Page**

- 添加了*应用*、*器件信息* 表、*引脚功能* 表、*ESD 额定值* 表、*热性能信息* 表、*特性* *说明* 部分、*器件功能模式*、*应用和实施*部分、*电源相关建议*部分、*布局*部分、*器件和文档支持*部分以及*机械、封装和可订购信息*部分。 ... 1
- 已删除 *订购信息* 表。 ... 1

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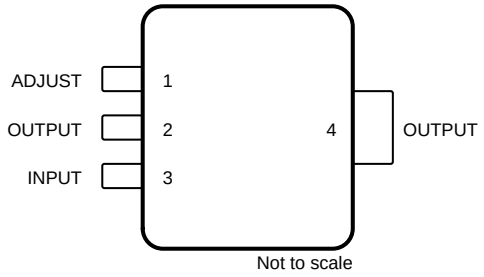
5 Pin Configuration and Functions

DCY Package
3-Pin SOT-223
Top View



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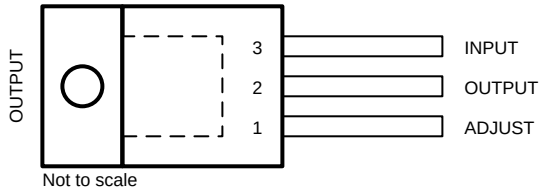
KCS or KCT Package
3-Pin TO-220
Top View



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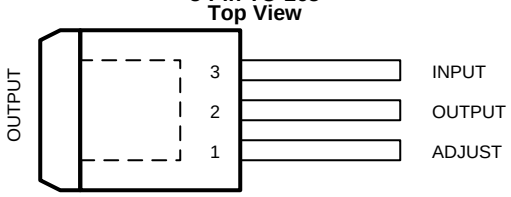
KTT Package
3-Pin TO-263
Top View



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Pin Functions

PIN			I/O	DESCRIPTION
NAME	TO-263, TO-220	SOT-223		
ADJUST	1	1	I	Output voltage adjustment pin. Connect to a resistor divider to set V_O
INPUT	3	3	I	Supply input pin
OUTPUT	2	2, 4	O	Voltage output pin

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6 Specifications

6.1 Absolute Maximum Ratings

over virtual junction temperature range (unless otherwise noted)(1)

		MIN	MAX	UNIT
$V_I - V_O$	Input-to-output differential voltage		40	V
T_J	Operating virtual junction temperature		150	°C
	Lead temperature 1,6 mm (1/16 in) from case for 10 s		260	°C
T_{stg}	Storage temperature	–65	150	°C

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

			MAX	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001(1)	2500	V
		Charged device model (CDM), per JEDEC specification JESD22-C101(2)	1000	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

		MIN	MAX	UNIT
V_O	Output voltage	1.25	37	V
$V_I - V_O$	Input-to-output differential voltage	3	40	V
I_O	Output current	0.01	1.5	A
T_J	Operating virtual junction temperature	0	125	°C

6.4 Thermal Information

THERMAL METRIC(1)		LM317				UNIT
		DCY (SOT-223)	KCS (TO-220)	KCT (TO-220)	KTT (TO-263)	
		4 PINS	3 PINS	3 PINS	3 PINS	
$R_{\theta(JA)}$	Junction-to-ambient thermal resistance	66.8	23.5	37.9	38.0	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	43.2	15.9	51.1	36.5	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	16.9	7.9	23.2	18.9	°C/W
ψ_{JT}	Junction-to-top characterization parameter	3.6	3.0	13.0	6.9	°C/W
ψ_{JB}	Junction-to-board characterization parameter	16.8	7.8	22.8	17.9	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	NA	0.1	4.2	1.1	°C/W

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report.

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6.5 Electrical Characteristics

over recommended ranges of operating virtual junction temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS(1)			MIN	TYP	MAX	UNIT
Line regulation(2)	$V_I - V_O$ = 3 V to 40 V		T_J = 25°C		0.01	0.04	%/V
			T_J = 0°C to 125°C		0.02	0.07	
Load regulation	I_O = 10 mA to 1500 mA	C_{ADJ}(3) = 10 μF, T_J = 25°C	V_O ≤ 5 V			25	mV
			V_O ≥ 5 V		0.1	0.5	$\%V_O$
		T_J = 0°C to 125°C	V_O ≤ 5 V		20	70	mV
			V_O ≥ 5 V		0.3	1.5	$\%V_O$
Thermal regulation	20-ms pulse,	T_J = 25°C			0.03	0.07	$\%V_O$/W
ADJUST terminal current					50	100	μA
Change in ADJUST terminal current	$V_I - V_O$ = 2.5 V to 40 V, P_D ≤ 20 W, I_O = 10 mA to 1500 mA				0.2	5	μA
Reference voltage	$V_I - V_O$ = 3 V to 40 V, P_D ≤ 20 W, I_O = 10 mA to 1500 mA			1.2	1.25	1.3	V
Output-voltage temperature stability	T_J = 0°C to 125°C				0.7		$\%V_O$
Minimum load current to maintain regulation	$V_I - V_O$ = 40 V				3.5	10	mA
Maximum output current	$V_I - V_O$ ≤ 15 V,	$P_D < P_{MAX}$(4)		1.5	2.2		A
	$V_I - V_O$ ≤ 40 V,	$P_D < P_{MAX}$(4),	T_J = 25°C	0.15	0.4		
RMS output noise voltage (% of V_O)	f = 10 Hz to 10 kHz,	T_J = 25°C			0.003		$\%V_O$
Ripple rejection	V_O = 10 V,	f = 120 Hz	C_{ADJ} = 0 μF(3)		57		dB
			C_{ADJ} = 10 μF(3)	62	64		
Long-term stability	T_J = 25°C				0.3	1	%/1k hr

(1) Unless otherwise noted, the following test conditions apply: $|V_I - V_O|$ = 5 V and I_{OMAX} = 1.5 A, T_J = 0°C to 125°C. Pulse testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible.
(2) Line regulation is expressed here as the percentage change in output voltage per 1-V change at the input.
(3) C_{ADJ} is connected between the ADJUST terminal and GND.
(4) Maximum power dissipation is a function of T_J(max), θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A) / \theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.

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6.6 Typical Characteristics

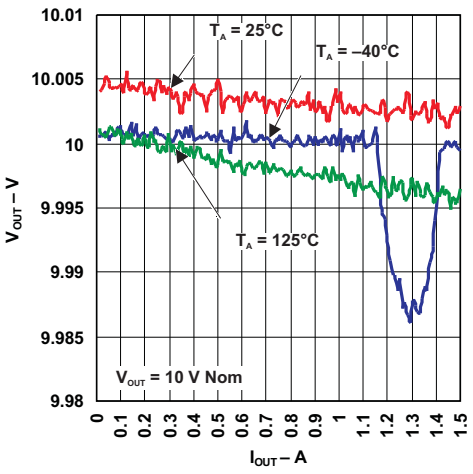

Figure 1. Load Regulation

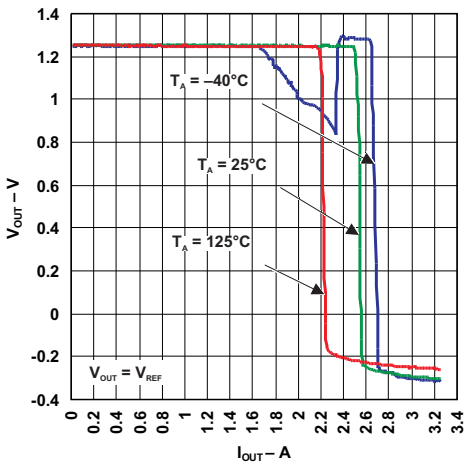

Figure 2. Load Regulation

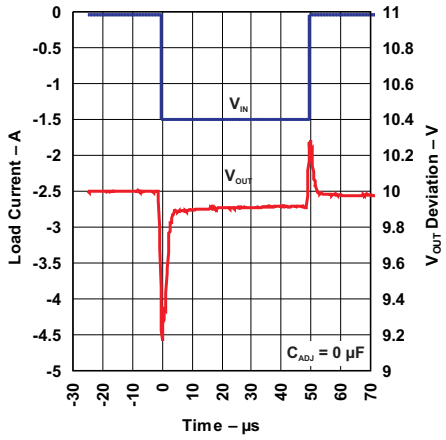

Figure 3. Load Transient Response

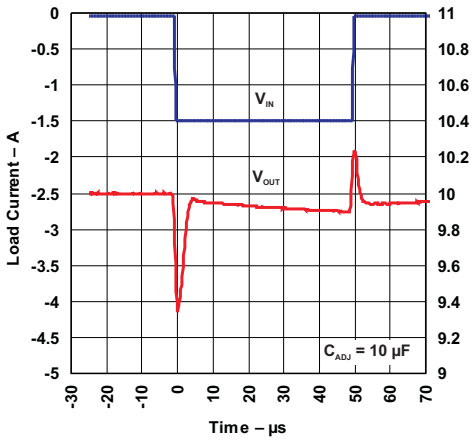

Figure 4. Load Transient Response

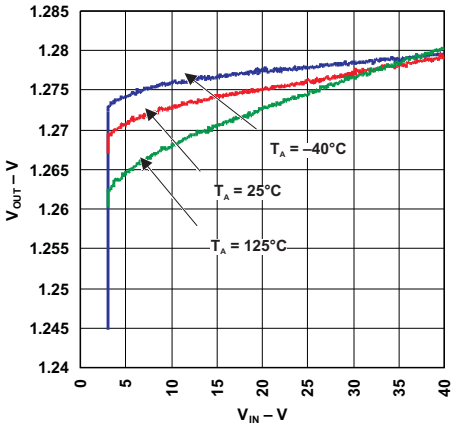

Figure 5. Line Regulation

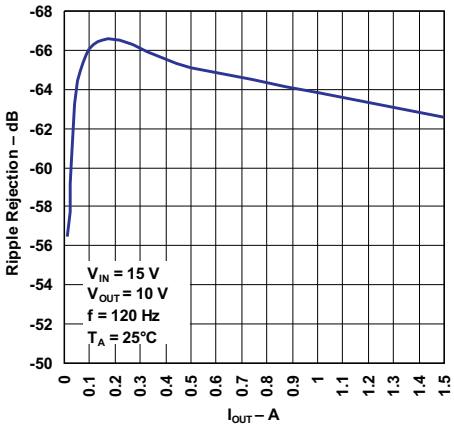

Figure 6. Ripple Rejection vs Output Current

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Typical Characteristics (continued)

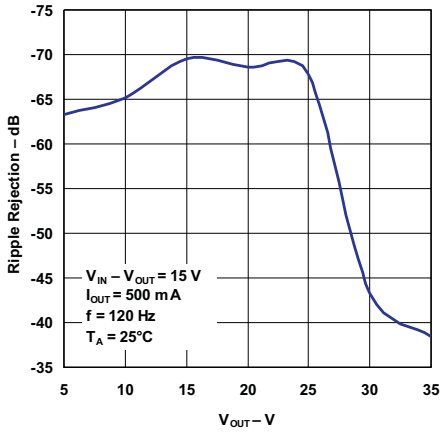

Figure 7. Ripple Rejection vs Output Voltage

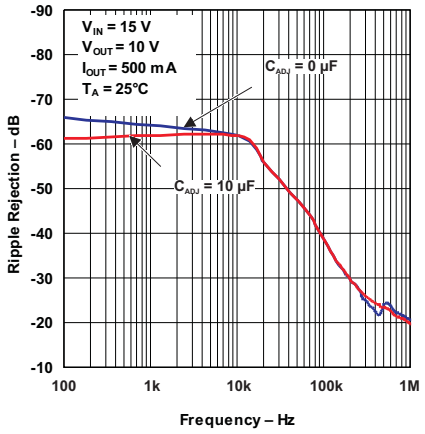

Figure 8. Ripple Rejection vs Frequency

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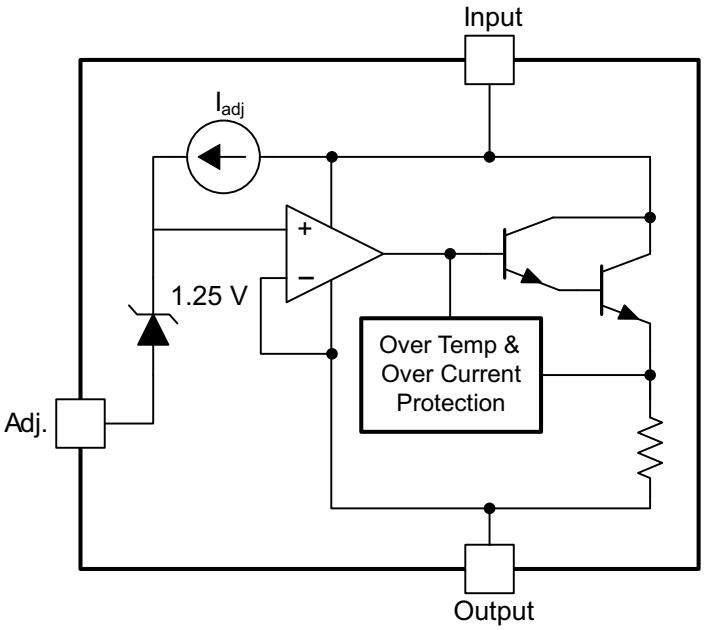
7 Detailed Description

7.1 Overview

The LM317 device is an adjustable three-terminal positive-voltage regulator capable of supplying up to 1.5 A over an output-voltage range of 1.25 V to 37 V. It requires only two external resistors to set the output voltage. The device features a typical line regulation of 0.01% and typical load regulation of 0.1%. It includes current limiting, thermal overload protection, and safe operating area protection. Overload protection remains functional even if the ADJUST terminal is disconnected.

The LM317 device is versatile in its applications, including uses in programmable output regulation and local on-card regulation. Or, by connecting a fixed resistor between the ADJUST and OUTPUT terminals, the LM317 device can function as a precision current regulator. An optional output capacitor can be added to improve transient response. The ADJUST terminal can be bypassed to achieve very high ripple-rejection ratios, which are difficult to achieve with standard three-terminal regulators.

7.2 Functional Block Diagram



7.3 Feature Description

7.3.1 NPN Darlington Output Drive

NPN Darlington output topology provides naturally low output impedance and an output capacitor is optional. 3-V headroom is recommended ($V_I – V_O$) to support maximum current and lowest temperature.

7.3.2 Overload Block

Over-current and over-temperature shutdown protects the device against overload or damage from operating in excessive heat.

7.3.3 Programmable Feedback

Op amp with 1.25-V offset input at the ADJUST terminal provides easy output voltage or current (not both) programming. For current regulation applications, a single resistor whose resistance value is 1.25 V/I_O and power rating is greater than $(1.25\ V)^2/R$ should be used. For voltage regulation applications, two resistors set the output voltage.

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7.4 Device Functional Modes

7.4.1 Normal Operation

The device OUTPUT pin will source current necessary to make OUTPUT pin 1.25 V greater than ADJUST terminal to provide output regulation.

7.4.2 Operation With Low Input Voltage

The device requires up to 3-V headroom (V_I – V_O) to operate in regulation. The device may drop out and OUTPUT voltage will be INPUT voltage minus drop out voltage with less headroom.

7.4.3 Operation at Light Loads

The device passes its bias current to the OUTPUT pin. The load or feedback must consume this minimum current for regulation or the output may be too high. See the *Electrical Characteristics* table for the minimum load current needed to maintain regulation.

7.4.4 Operation In Self Protection

When an overload occurs the device shuts down Darlington NPN output stage or reduces the output current to prevent device damage. The device will automatically reset from the overload. The output may be reduced or alternate between on and off until the overload is removed.

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8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The flexibility of the LM317 allows it to be configured to take on many different functions in DC power applications.

8.2 Typical Application

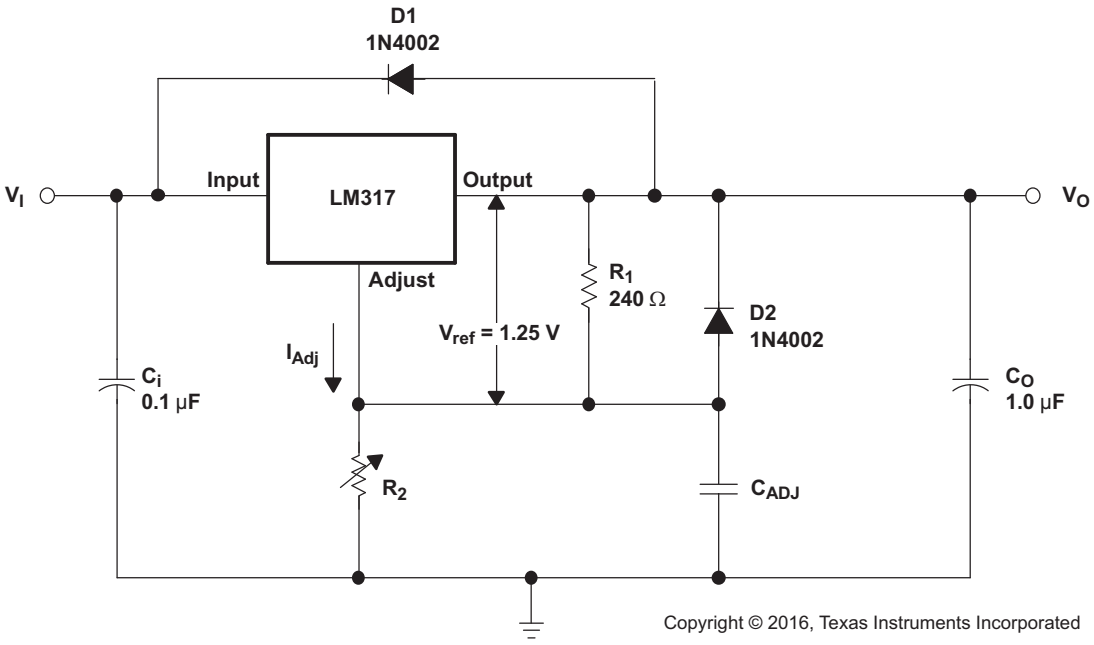

Figure 9. Adjustable Voltage Regulator

8.2.1 Design Requirements

- R1 and R2 are required to set the output voltage.
- C_{ADJ} is recommended to improve ripple rejection. It prevents amplification of the ripple as the output voltage is adjusted higher.
- C_i is recommended, particularly if the regulator is not in close proximity to the power-supply filter capacitors. A 0.1-µF or 1-µF ceramic or tantalum capacitor provides sufficient bypassing for most applications, especially when adjustment and output capacitors are used.
- C_O improves transient response, but is not needed for stability.
- Protection diode D2 is recommended if C_{ADJ} is used. The diode provides a low-impedance discharge path to prevent the capacitor from discharging into the output of the regulator.
- Protection diode D1 is recommended if C_O is used. The diode provides a low-impedance discharge path to prevent the capacitor from discharging into the output of the regulator.

8.2.2 Detailed Design Procedure

V_O is calculated as shown in Equation 1. I_{ADJ} is typically 50 µA and negligible in most applications.

$$V_O = V_{REF} (1 + R2 / R1) + (I_{ADJ} \times R2) \quad (1)$$

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Typical Application (continued)

8.2.3 Application Curves

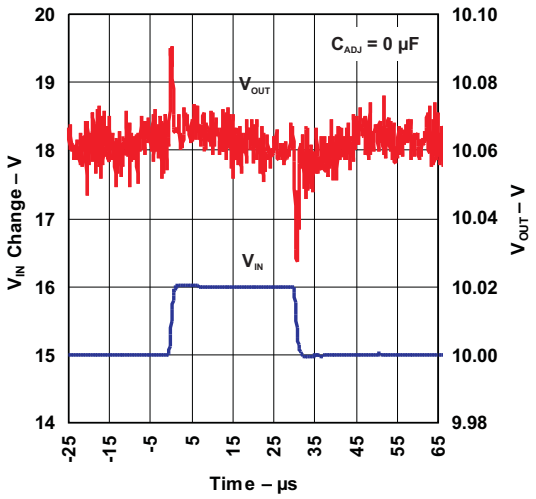

Figure 10. Line-Transient Response

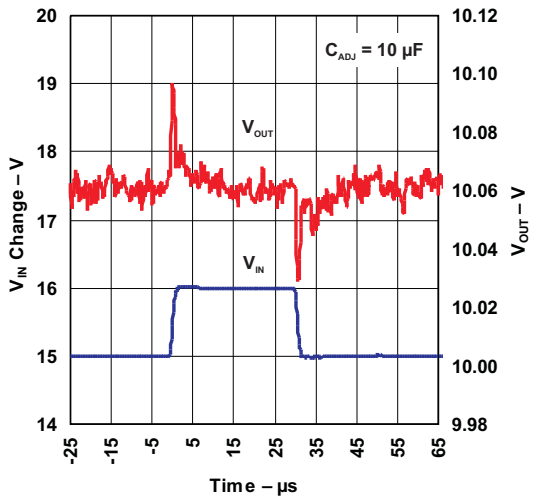

Figure 11. Line-Transient Response

8.3 System Examples

8.3.1 0-V to 30-V Regulator Circuit

Here, the voltage is determined by $V_{OUT} = V_{REF}\left(1 + \frac{R_2 + R_3}{R_1}\right) - 10\,V$

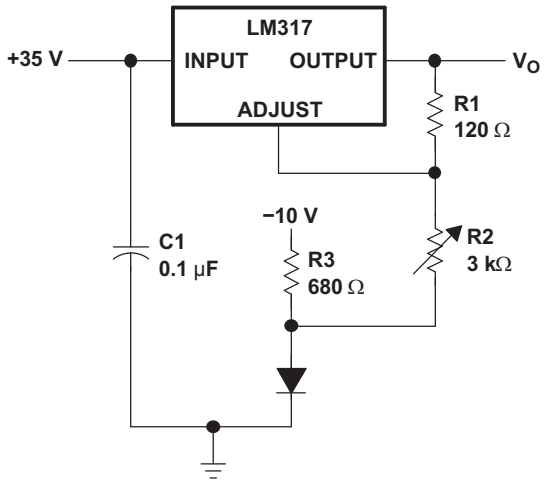

Figure 12. 0-V to 30-V Regulator Circuit

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System Examples (continued)

8.3.2 Adjustable Regulator Circuit With Improved Ripple Rejection

C2 helps to stabilize the voltage at the adjustment pin, which helps reject noise. Diode D1 exists to discharge C2 in case the output is shorted to ground.

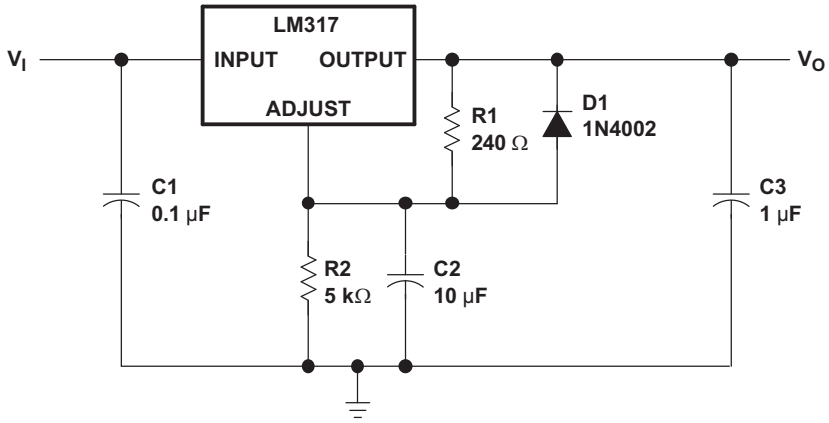

Figure 13. Adjustable Regulator Circuit with Improved Ripple Rejection

8.3.3 Precision Current-Limiter Circuit

This application limits the output current to the I_{LIMIT} in the diagram.

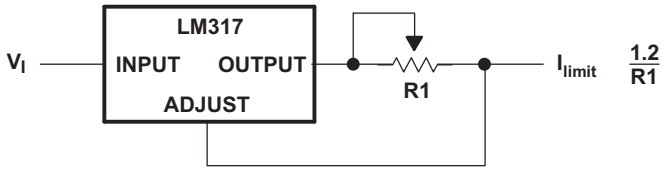

Figure 14. Precision Current-Limiter Circuit

8.3.4 Tracking Preregulator Circuit

This application keeps a constant voltage across the second LM317 in the circuit.

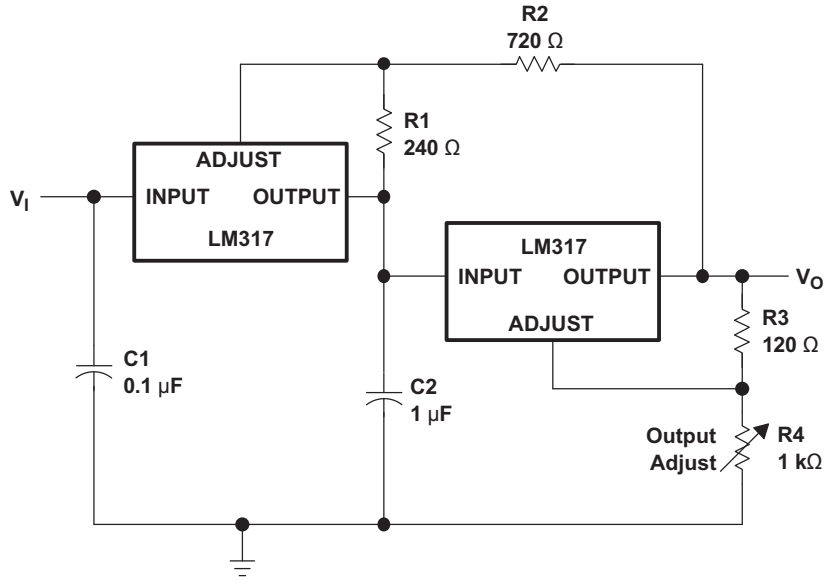

Figure 15. Tracking Preregulator Circuit

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System Examples (continued)

8.3.5 1.25-V to 20-V Regulator Circuit With Minimum Program Current

Because the value of V_{REF} is constant, the value of R1 determines the amount of current that flows through R1 and R2. The size of R2 determines the IR drop from ADJUSTMENT to GND. Higher values of R2 translate to higher V_{OUT}.

$$V_{OUT} = V_{REF}\left(1 + \frac{R_2 + R_3}{R_1}\right) - 10\,V \quad (2)$$

$$(R1 + R2)\min = V_O I_{reg(min)} \quad (3)$$

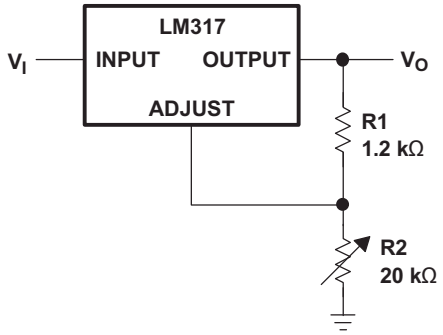

Figure 16. 1.25-V to 20-V Regulator Circuit With Minimum Program Current

8.3.6 Battery-Charger Circuit

The series resistor limits the current output of the LM317, minimizing damage to the battery cell.

$$V_{OUT} = 1.25V \times \left(\frac{R2}{R1 + 1}\right) \quad (4)$$

$$I_{OUT}(short) = \frac{1.25V}{RS} \quad (5)$$

$$\text{Output impendance} = RS \times \left(\frac{R2}{R1 + 1}\right) \quad (6)$$

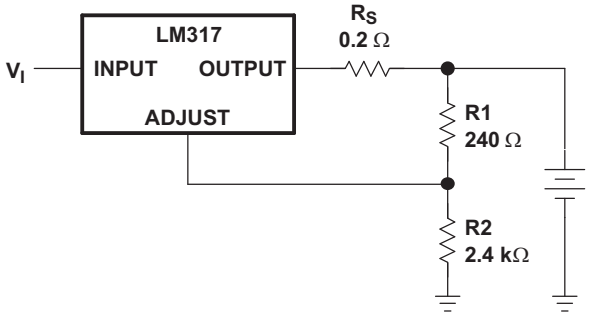

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Figure 17. Battery-Charger Circuit

System Examples (continued)

8.3.7 50-mA Constant-Current Battery-Charger Circuit

The current limit operation mode can be used to trickle charge a battery at a fixed current. I_{CHG} = 1.25 V ÷ 24 Ω. V_I should be greater than V_{BAT} + 4.25 V. (1.25 V [V_{REF}] + 3 V [headroom])

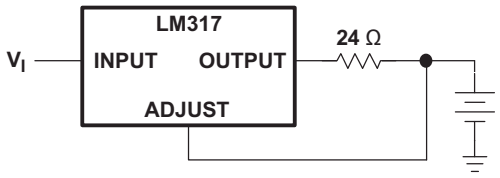

Figure 18. 50-mA Constant-Current Battery-Charger Circuit

8.3.8 Slow Turn-On 15-V Regulator Circuit

The capacitor C1, in combination with the PNP transistor, helps the circuit to slowly start supplying voltage. In the beginning, the capacitor is not charged. Therefore output voltage starts at V_{C1}+ V_{BE} + 1.25 V = 0 V + 0.65 V + 1.25 V = 1.9 V. As the capacitor voltage rises, V_{OUT} rises at the same rate. When the output voltage reaches the value determined by R1 and R2, the PNP will be turned off.

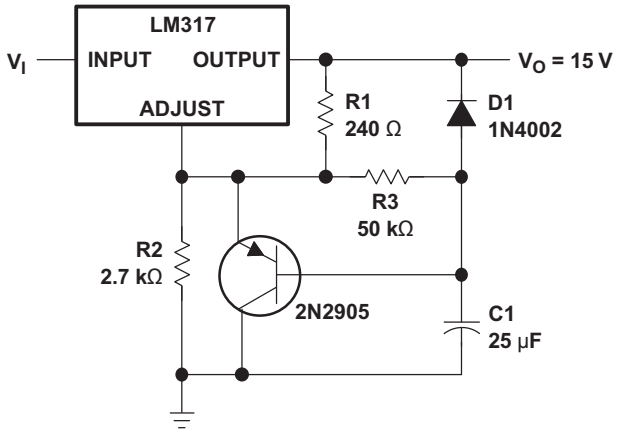

Figure 19. Slow Turn-On 15-V Regulator Circuit

8.3.9 AC Voltage-Regulator Circuit

These two LM317s can regulate both the positive and negative swings of a sinusoidal AC input.

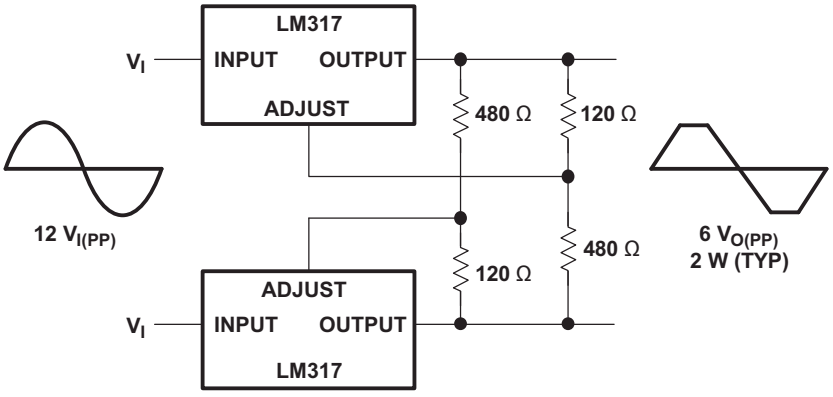

Figure 20. AC Voltage-Regulator Circuit

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System Examples (continued)

8.3.10 Current-Limited 6-V Charger Circuit

As the charge current increases, the voltage at the bottom resistor increases until the NPN starts sinking current from the adjustment pin. The voltage at the adjustment pin drops, and consequently the output voltage decreases until the NPN stops conducting.

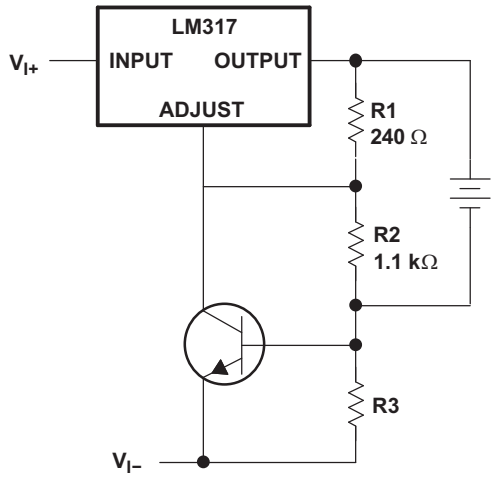

Figure 21. Current-Limited 6-V Charger Circuit

8.3.11 Adjustable 4-A Regulator Circuit

This application keeps the output current at 4 A while having the ability to adjust the output voltage using the adjustable (1.5 kΩ in schematic) resistor.

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System Examples (continued)

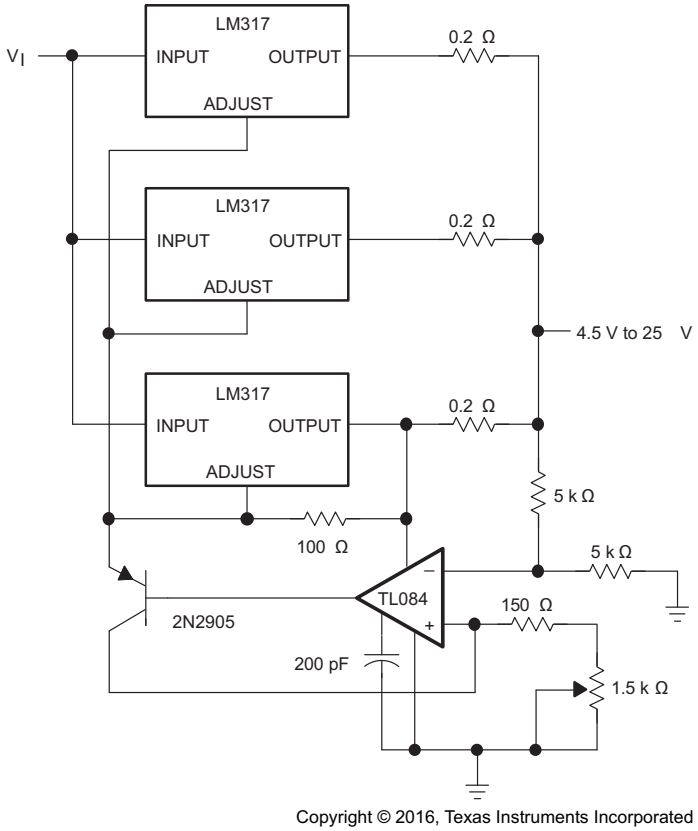

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Figure 22. Adjustable 4-A Regulator Circuit

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System Examples (continued)

8.3.12 High-Current Adjustable Regulator Circuit

The NPNs at the top of the schematic allow higher currents at V_{OUT} than the LM317 can provide, while still keeping the output voltage at levels determined by the adjustment pin resistor divider of the LM317.

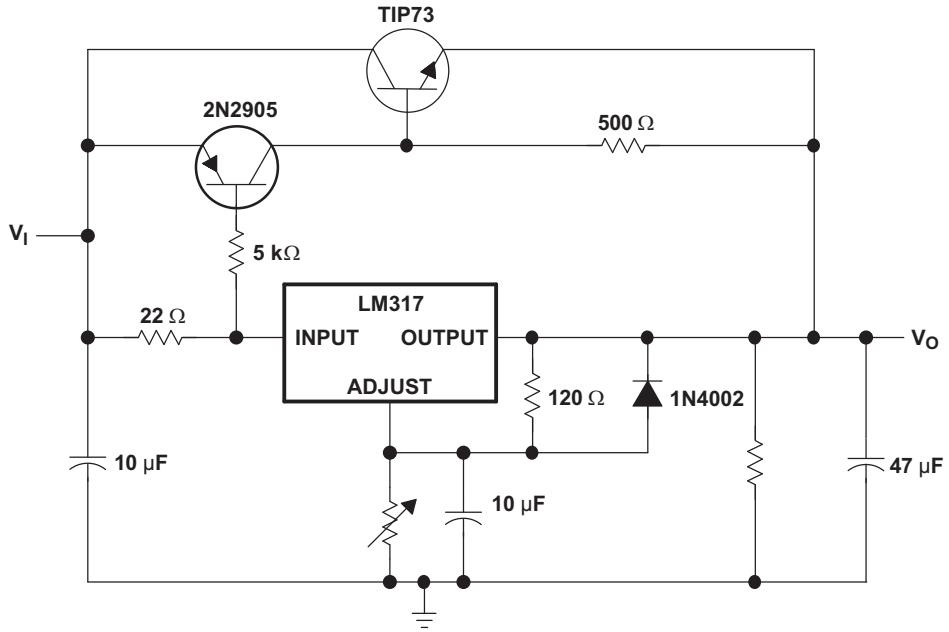

Figure 23. High-Current Adjustable Regulator Circuit

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9 Power Supply Recommendations

The LM317 is designed to operate from an input voltage supply range between 1.25 V to 37 V greater than the output voltage. If the device is more than six inches from the input filter capacitors, an input bypass capacitor, 0.1 μF or greater, of any type is needed for stability.

10 Layout

10.1 Layout Guidelines

- TI recommends that the input terminal be bypassed to ground with a bypass capacitor.
- The optimum placement is closest to the input terminal of the device and the system GND. Take care to minimize the loop area formed by the bypass-capacitor connection, the input terminal, and the system GND.
- For operation at full rated load, TI recommends to use wide trace lengths to eliminate I × R drop and heat dissipation.

10.2 Layout Example

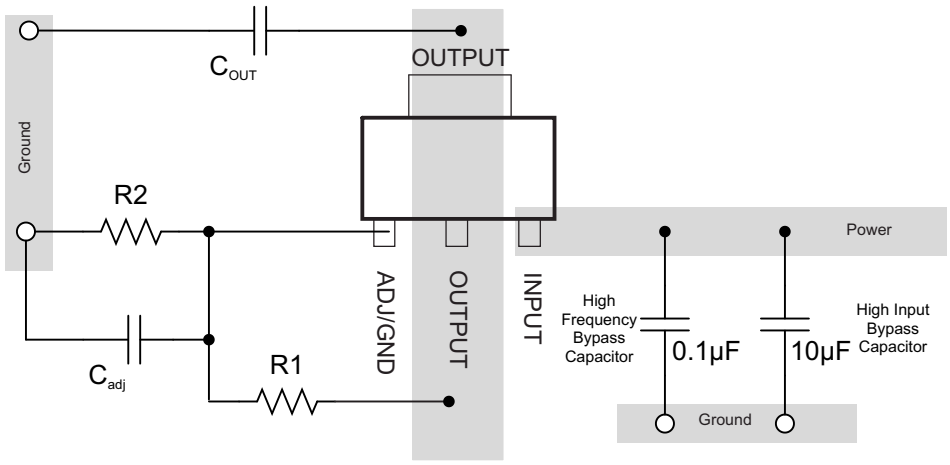

Figure 24. Layout Example

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11.5 Glossary

SLYZ022 — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

12 机械、封装和可订购信息

以下页面包含机械、封装和可订购信息。这些信息是指定器件的最新可用数据。这些数据如有变更，恕不另行通知和修订此文档。如欲获取此数据表的浏览器版本，请参阅左侧的导航。

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